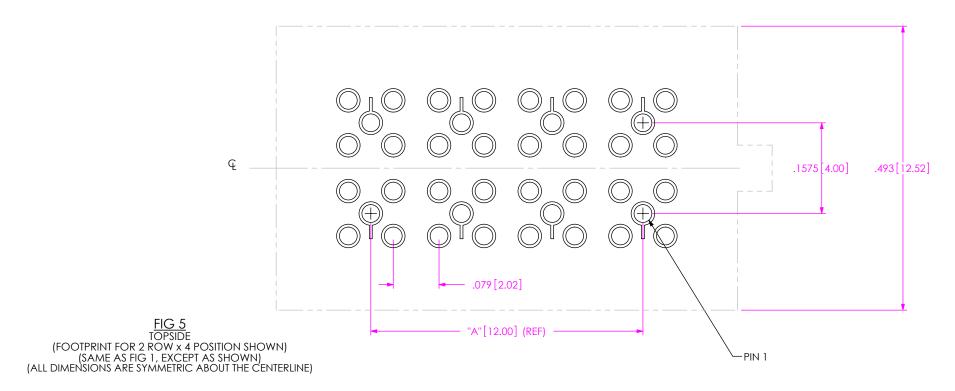


RECOMMENDED PCB LAYOUT FOR IP5-XX-XX.X-X-X-FOOTPRINT



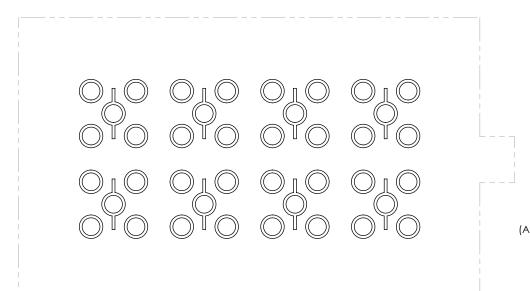


FIG 6

BOTTOMSIDE

(FOOTPRINT FOR 2 ROW x 4 POSITION SHOWN)

(SAME AS FIG 2, EXCEPT AS SHOWN)

(ALL DIMENSIONS ARE SYMMETRIC ABOUT THE CENTERLINE)

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REVISION F

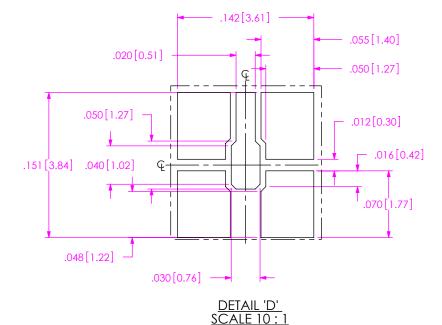
RECOMMENDED STENCIL LAYOUT FOR IP5-XX-XX.X-X-X-FOOTPRINT

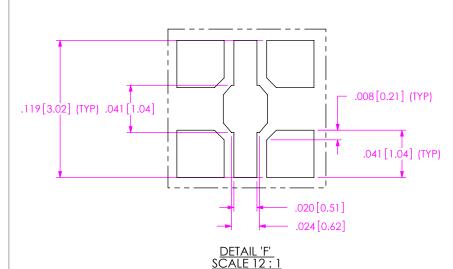
1. STENCIL TO BE .0050[.127] THICK.
2. TO ACHIEVE THE DESIRED SOLDER VOLUME, WE RECOMMEND THAT SOLDER PASTE BE PRINTED ON

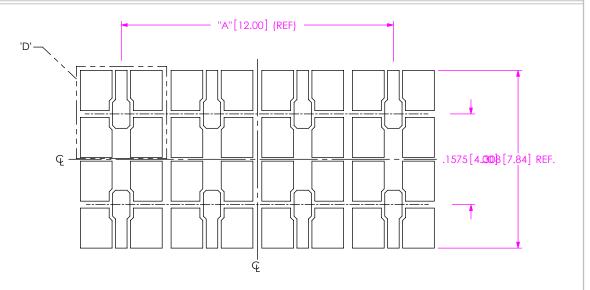
BOTH SIDES OF THE PCB USING THE LAYOUTS IN FIGURES 7 AND 8 .055 [1.40] .

3. SINGLE SIDE SOLDER PRINTING MAY BE POSSIBLE BY ADJUSTING PRINTER PROCESS VARIABLES. CONTACT SAMTEC'S INTERCONNECT PROCESSING GROUP AT (800) SAMTEC9 OR IPG@SAMTEC.COM FOR MORE INFORMATION.

4. NOTE DELETED.







TOP SIDE (STENCIL FOR 2 ROW x 4 POSITION SHOWN) (SAME AS FIG 2, EXCEPT AS SHOWN) (ALL DIMENSIONS ARE SYMMETRIC ABOUT THE CENTERLINE)

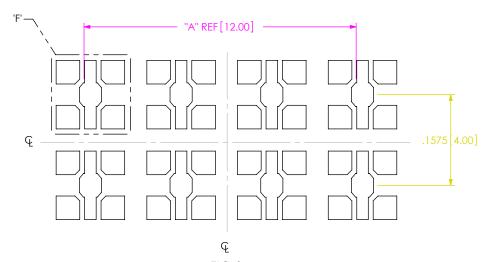


FIG 8 BOTTOM SIDE (STENCIL FOR 2 ROW x 4 POSITION SHOWN)

(SAME AS FIG 2, EXCEPT AS SHOWN)
(ALL DIMENSIONS ARE SYMMETRIC ABOUT THE CENTERLINE)

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